□ MN101C66D, MN101C66G

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Туре		MN101C66D	MN101C66G (under development)			
ROM (×8-bit)	64 K	128 K			
RAM (×8-bit)	2 K	4 K			
Packa	ge	QFP084-P-1818E *Lead-free, LQFP080-P-14144	A *Lead-free, TQFP080-P-1212D *Lead-free (under plannning)			
	um Instruction tion Time	 0.1 μs (at 4.5 V to 5.5 V, 20 MHz) 0.25 μs (at 2.7 V to 5.5 V, 8 MHz) 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)*1 *1 The lower limit for operation guarantee for flash memory built-in type is 2.5 V. The lower limit for operation guarantee for EPROM built-in type is 2.3 V. 				
Interru	ıpts		• Timer 1 • Timer 2 • Timer 3 • Timer 6 • Time base erial 0 (2 systems) • Serial 2 • A/D conversion finish			
Timer	Counter	measurement) (square-wave/PWM output to la Clock source 1/2, 1/4 of syst	tem clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation y; 1/1 of XI oscillation clock frequency; external clock input			
		Timer counter 1 : 8-bit × 1 (square-wave output, event count, synchronous output event) Clock source				
		Interrupt source coincidence wi	ith compare register 1			
		Timer counter 0, 1 can be cascade-connected.				
		simple pulse width measurement) (square-wav Clock source 1/2, 1/4 of syst	bit PWM output, event count, synchronous output event, re/PWM output to large current terminal P52 possible) tem clock frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation sy; 1/1 of XI oscillation clock frequency; external clock input ith compare register 2			
		Clock source 1/2, 1/8 of syst	f remote control carrier, serial 0 baud rate timer) tem clock frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC ck frequency; 1/1 of XI oscillation clock frequency; external ith compare register 3			
		Timer counter 2, 3 can be cascade-connected.				
		Timer counter 6 : 8-bit freerun timer Clock source 1/1 of system of	clock frequency; 1/1, 1/4096, 1/8192 of OSC oscillation clock , 1/4096, 1/8192 of XI oscillation clock frequency			
		Interrupt source coincidence wi				
		output evevt, pulse width measurement, input possible) Clock source 1/1, 1/2, 1/4, 1	tt (cycle / duty continuous variable), event count, synchronous capture) (square-wave/PWM output to large current terminal P51 /16 of system clock frequency; 1/1, 1/2, 1/4, 1/16 of OSC ck frequency; 1/1, 1/2, 1/4, 1/16 of external clock input frequency ith compare register 7 (2 lines)			

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Timer Counter (Continue)		Timer counter 8: 16 bit × 1 (square-wave/16-bit PWM output [duty continuous variable], event count, pulse width measurement, inputcapture) (square-wave/PWM output to large current terminal P53 possible) Clock source							
		Time base timer (one-minute count setting) Clock source							
		Watchd	og timer Interrupt source 1/65536, 1/262144, 1/1048576 of system cl	lock frequ	ency				
Serial Interface		Serial 0 : synchronous type/UART (full-duplex) × 1 Clock source							
I/O Pins	10		: synchronous type × 1 Clock source ····································	k frequenc	сy				
I/O PINS	I/O	(60)	 61 • Common use • Specified pull-up resistor available • Input/output selectable (bit unit) (60) (): LQFP080-P-1414A,TQFP080-P-1212D 						
	Input	4 • Common use • Specified pull-up resistor available (3) (): LQFP080-P-1414A,TQFP080-P-1212							
A/D Inputs	·	10-bit × 8-ch. (with S/H)							
LCD		32 segments × 4 commons (static, 1/2, 1/3, or 1/4 duty) LCD power supply separated from VDD (usable if VLCD ≤VDD) LCD power shunt resistance contained							
Special Ports		Buzzer	output, remote control carrier signal output, high-current drive port						
Electrical Cha Supply curren									
Parameter		Symbol	Condition	Limit		Un			
				min	typ	max			
		IDD1	fosc = 20 MHz, VDD = 5 V		25	60	mA		
Operatingsupplycurrent		IDD2	fosc = 8 MHz, VDD = 5 V		10	25	mA		
		IDD3	fx = 32 kHz, VDD = 3 V		30	100	μA		
Supply current at HALT		IDD4	$fx = 32 \text{ kHz}, \text{ VDD} = 3 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$		4	8	μA		
		IDD5	$fx = 32 \text{ kHz}, \text{VDD} = 3 \text{ V}, \text{ Ta} = -40^{\circ}\text{C} \text{ to} +85^{\circ}\text{C}$			30	μA		
Supply current at	STOP	IDD6	VDD = 5 V, Ta = 25°C			2	μA		

Supply current at STOP

IDD7

VDD = 5 V, Ta = -40° C to $+85^{\circ}$ C

μΑ

50





TQFP080-P-1212D *Lead-free (under plannnig)

Support Tool

In-circuit Emulator	-	IC / D + PX-PRB101C66-QFP084-P-1818E-M IC / D + PX-PRB101C66-LQFP080-P-1414A-M	
EPROM Built-in Type	Туре	MN101CP66D	
	ROM (× 8-bit)	64 K	
	RAM (× 8-bit)	2 K	
	Minimum instruction execution time	0.1 µs (at 4.5 V to 5.5 V, 20 MHz)	
		0.25 µs (at 2.7 V to 5.5 V, 8 MHz)	
		62.5 µs (at 2.3 V to 5.5 V, 32 kHz)	
	Package	LQFP080-P-1414A *Lead-free, QFP084-P-1818E *Lead-free,	
		TQFP080-P-1212D *Lead-free (under planning)	
Flash Memory Built-in Type	Туре	MN101CF66G [ES (Engineering Sample) available]	
	ROM (× 8-bit)	128 K	
	RAM (× 8-bit)	4 K	
	Minimum instruction execution time	0.1 µs (at 4.5 V to 5.5 V, 20 MHz)	
		$0.25~\mu s$ (at 2.7 V to 5.5 V, 8 MHz)	
		$62.5~\mu s$ (at 2.5 V to 5.5 V, 32 kHz)	
	Package	LQFP080-P-1414A *Lead-free, QFP084-P-1818E *Lead-free,	
		TQFP080-P-1212D *Lead-free (under planning)	

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